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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	13
Program Memory Size	896B (512 x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	80 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lc554-04i-ss

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

1.0 GENERAL DESCRIPTION

The PIC16C55X are 18, 20 and 28-Pin EPROM-based members of the versatile PIC16CXX family of low cost, high performance, CMOS, fully-static, 8-bit microcontrollers.

All PIC[®] microcontrollers employ an advanced RISC architecture. The PIC16C55X have enhanced core features, eight-level deep stack, and multiple internal and external interrupt sources. The separate instruction and data buses of the Harvard architecture allow a 14-bit wide instruction word with the separate 8-bit wide data. The two-stage instruction pipeline allows all instructions to execute in a single-cycle, except for program branches (which require two cycles). A total of 35 instructions (reduced instruction set) are available. Additionally, a large register set gives some of the architectural innovations used to achieve a very high performance.

PIC16C55X microcontrollers typically achieve a 2:1 code compression and a 4:1 speed improvement over other 8-bit microcontrollers in their class.

The PIC16C554 has 80 bytes of RAM. The PIC16C557 and PIC16C558 have 128 bytes of RAM. The PIC16C554 and PIC16C558 have 13 I/O pins and an 8bit timer/counter with an 8-bit programmable prescaler. The PIC16C557 has 22 I/O pins and an 8-bit timer/ counter with an 8-bit programmable prescaler.

PIC16C55X devices have special features to reduce external components, thus reducing cost, enhancing system reliability and reducing power consumption. There are four oscillator options, of which the single pin RC oscillator provides a low cost solution, the LP oscillator minimizes power consumption, XT is a standard crystal, and the HS is for high speed crystals. The SLEEP (power-down) mode offers power saving. The user can wake-up the chip from SLEEP through several external and internal interrupts and RESET.

A highly reliable Watchdog Timer, with its own on-chip RC oscillator, provides protection against software lock-up. A UV-erasable CERDIP packaged version is ideal for code development while the cost effective One-Time Programmable (OTP) version is suitable for production in any volume.

Table 1-1 shows the features of the PIC16C55X midrange microcontroller families.

A simplified block diagram of the PIC16C55X is shown in Figure 3-1.

The PIC16C55X series fit perfectly in applications ranging from motor control to low power remote sensors. The EPROM technology makes customization of application programs (detection levels, pulse generation, timers, etc.) extremely fast and convenient. The small footprint packages make this microcontroller series perfect for all applications with space limitations. Low cost, low power, high performance, ease of use and I/O flexibility make the PIC16C55X very versatile.

1.1 Family and Upward Compatibility

Users familiar with the family of microcontrollers will realize that this is an enhanced version of the architecture. Please refer to Appendix A for a detailed list of enhancements. Code written for can be easily ported to PIC16C55X family of devices (Appendix B).

The PIC16C55X family fills the niche for users wanting to migrate up from the family and not needing various peripheral features of other members of the PIC16XX mid-range microcontroller family.

1.2 Development Support

The PIC16C55X family is supported by a full-featured macro assembler, a software simulator, an in-circuit emulator, a low cost development programmer and a full-featured programmer.

2.0 PIC16C55X DEVICE VARIETIES

A variety of frequency ranges and packaging options are available. Depending on application and production requirements, the proper device option can be selected using the information in the PIC16C55X Product Identification System section at the end of this data sheet. When placing orders, please use this page of the data sheet to specify the correct part number.

2.1 UV Erasable Devices

The UV erasable version, offered in CERDIP package, is optimal for prototype development and pilot programs. This version can be erased and reprogrammed to any of the oscillator modes.

Microchip's PICSTART[®] and PROMATE[®] programmers both support programming of the PIC16C55X.

2.2 One-Time Programmable (OTP) Devices

The availability of OTP devices is especially useful for customers who need the flexibility for frequent code updates and small volume applications. In addition to the program memory, the configuration bits must also be programmed.

2.3 Quick-Turnaround Production (QTP) Devices

Microchip offers a QTP Programming Service for factory production orders. This service is made available for users who choose not to program a medium-to-high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices, but with all EPROM locations and configuration options already programmed by the factory. Certain code and prototype verification procedures apply before production shipments are available. Please contact your Microchip Technology sales office for more details.

2.4 Serialized Quick-Turnaround Production (SQTP[™]) Devices

Microchip offers a unique programming service where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random or sequential.

Serial programming allows each device to have a unique number which can serve as an entry code, password or ID number.

4.2.2.4 PCON Register

The PCON register contains a flag bit to differentiate between a Power-on Reset, an external MCLR Reset or WDT Reset. See Section 6.3 and Section 6.4 for detailed RESET operation.

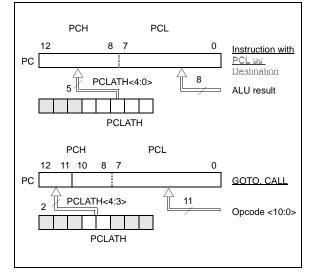
REGISTER 4-4: PCON REGISTER (ADDRESS 8Eh) U-0 U-0 U-0 R/W-0 U-0 U-0 U-0 U-0 POR bit7 bit 7-2 Unimplemented: Read as '0' bit 1 POR: Power-on Reset status bit 1 = No Power-on Reset occurred 0 = Power-on Reset occurred bit 0 Unimplemented: Read as '0' Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit0

4.3 PCL and PCLATH

The program counter (PC) is 13-bits wide. The low byte comes from the PCL register, which is a readable and writable register. The high bits (PC<12:8>) are not directly readable or writable and come from PCLATH. On any RESET, the PC is cleared. Figure 4-6 shows the two situations for the loading of the PC. The upper example in the figure shows how the PC is loaded on a write to PCL (PCLATH<4:0> \rightarrow PCH). The lower example in Figure 4-6 shows how the PC is loaded during a CALL or GOTO instruction (PCLATH<4:3> \rightarrow PCH).

FIGURE 4-6: LOADING OF PC IN DIFFERENT SITUATIONS



4.3.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When doing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256 byte block). Refer to the application note *"Implementing a Table Read"* (AN556).

4.3.2 STACK

The PIC16C55X family has an 8-level deep x 13-bit wide hardware stack (Figure 4-1 and Figure 4-2). The stack space is not part of either program or data space and the stack pointer is not readable or writable. The PC is PUSHed onto the stack when a CALL instruction is executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RET-FIE instruction execution. PCLATH is not affected by a PUSH or POP operation.

The stack operates as a circular buffer. This means that after the stack has been PUSHed eight times, the ninth push overwrites the value that was stored from the first push. The tenth push overwrites the second push (and so on).

Note 1: There are no status bits to indicate stack overflow or stack underflow conditions.

2: There are no instructions mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, RETURN, RETLW and RETFIE instructions, or vectoring to an interrupt address.

4.4 Indirect Addressing, INDF and FSR Registers

The INDF register is not a physical register. Addressing the INDF register will cause indirect addressing.

Indirect addressing is possible by using the INDF register. Any instruction using the INDF register actually accesses data pointed to by the file select register (FSR). Reading INDF itself indirectly will produce 00h. Writing to the INDF register indirectly results in a nooperation (although status bits may be affected). An effective 9-bit address is obtained by concatenating the 8-bit FSR register and the IRP bit (STATUS<7>), as shown in Figure 4-7. However, IRP is not used in the PIC16C55X.

A simple program to clear RAM locations 20h-2Fh using indirect addressing is shown in Example 4-1.

EXAMP	LE 4-1:	INDIR	INDIRECT ADDRESSING				
NEXT	movlw movwf clrf incf btfss goto	0x20 FSR INDF FSR FSR,4 NEXT	<pre>;initialize pointer ;to RAM ;clear INDF register ;inc pointer ;all done? ;no clear next ;yes continue</pre>				

CONTINUE:

5.4 I/O Programming Considerations

5.4.1 BI-DIRECTIONAL I/O PORTS

Any instruction which writes, operates internally as a read followed by a write operation. The BCF and BSF instructions, for example, read the register into the CPU, execute the bit operation and write the result back to the register. Caution must be used when these instructions are applied to a port with both inputs and outputs defined. For example, a BSF operation on bit5 of PORTB will cause all eight bits of PORTB to be read into the CPU. Then the BSF operation takes place on bit5 and PORTB is written to the output latches. If another bit of PORTB is used as a bi-directional I/O pin (e.g., bit 0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and re-written to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the Input mode, no problem occurs. However, if bit 0 is switched into Output mode later on, the content of the data latch may now be unknown.

Reading the port register, reads the values of the port pins. Writing to the port register writes the value to the port latch. When using read-modify-write instructions (ex. BCF, BSF, etc.) on a port, the value of the port pins is read, the desired operation is done to this value, and this value is then written to the port latch.

Example 5-1 shows the effect of two sequential read-modify-write instructions (ex., ${\tt BCF}$, ${\tt BSF}$, etc.) on an I/O port.

A pin actively outputting a low or high should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

6.4.5 POWER CONTROL/STATUS REGISTER (PCON)

Bit1 is POR (Power-on Reset). It is a '0' on Power-on Reset and unaffected otherwise. The user must write a '1' to this bit following a Power-on Reset. On a subsequent RESET if POR is '0', it will indicate that a Poweron Reset must have occurred (VDD may have gone too low).

TABLE 6-3: TIMEOUT IN VARIOUS SITUATIONS

Oscillator	Powe	Wake-up from	
Configuration	PWRTE = 0	PWRTE = 1	SLEEP
XT, HS, LP	72 ms + 1024 Tosc	1024 Tosc	1024 Tosc
RC	72 ms	_	—

TABLE 6-4: STATUS BITS AND THEIR SIGNIFICANCE

POR	то	PD			
0	1	1	Power-on Reset		
0	0	Х	Illegal, TO is set on POR		
0	Х	0	Illegal, PD is set on POR		
1	0	u	WDT Reset		
1	0	0	VDT Wake-up		
1	u	u	ICLR Reset during normal operation		
1	1	0	MCLR Reset during SLEEP		

PIC16C55X

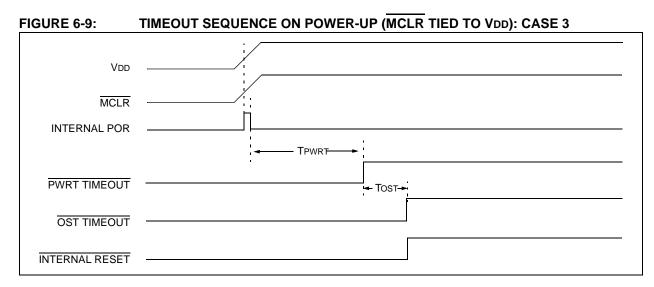
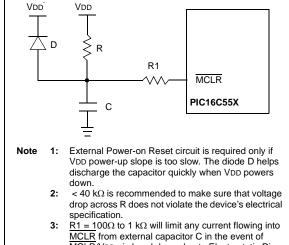


FIGURE 6-10: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



MCLR/VPP pin breakdown due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

6.9 Code Protection

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

Note:	Microchip	does	not	recommend	code
	protecting	windov	ved d	evices.	

6.10 ID Locations

Four memory locations (2000h-2003h) are designated as ID locations where the user can store checksum or other code-identification numbers. These locations are not accessible during normal execution but are readable and writable during program/verify.

6.11 In-Circuit Serial Programming™

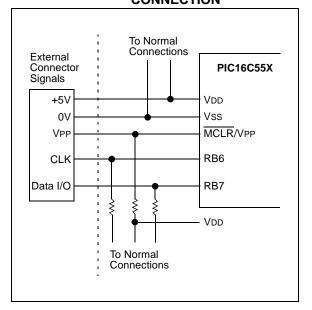
The PIC16C55X microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground, and the programming voltage. This allows customers to manufacture boards with unprogrammed devices, and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

The device is placed into a Program/Verify mode by holding the RB6 and RB7 pins low while raising the MCLR (VPP) pin from VIL to VIHH (see programming specification). RB6 becomes the programming clock and RB7 becomes the programming data. Both RB6 and RB7 are Schmitt Trigger inputs in this mode.

After RESET, to place the device into Programming/ Verify mode, the program counter (PC) is at location 00h. A 6-bit command is then supplied to the device. Depending on the command, 14 bits of program data are then supplied to or from the device, depending if the command was a load or a read. For complete details of serial programming, please refer to the PIC16C6X/7X Programming Specifications (Literature #DS30228).

A typical in-circuit serial programming connection is shown in Figure 6-15.

FIGURE 6-15: TYPICAL IN-CIRCUIT SERIAL PROGRAMMING CONNECTION



8.0 INSTRUCTION SET SUMMARY

Each PIC16C55X instruction is a 14-bit word divided into an OPCODE which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16C55X instruction set summary in Table 8-2 lists **byte-oriented**, **bitoriented**, and **literal and control** operations. Table 8-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an eight or eleven bit constant or literal value.

TABLE 8-1:OPCODE FIELD
DESCRIPTIONS

Field	Description				
f	Register file address (0x00 to 0x7F)				
W	Working register (accumulator)				
b	Bit address within an 8-bit file register				
k	Literal field, constant data or label				
 Don't care location (= 0 or 1) The assembler will generate code with is the recommended form of use for con ity with all Microchip software tools. 					
d	Destination select; d = 0: store result in W, d = 1: store result in file register f. Default is d = 1				
label	Label name				
TOS	Top of Stack				
PC	Program Counter				
PCLATH	Program Counter High Latch				
GIE	Global Interrupt Enable bit				
WDT	Watchdog Timer/Counter				
то	Timeout bit				
PD	Power-down bit				
dest	Destination either the W register or the specified register file location				
[]	Options				
()	Contents				
\rightarrow	Assigned to				
< >	Register bit field				
∈	In the set of				
italics	User defined term (font is courier)				

The instruction set is highly orthogonal and is grouped into three basic categories:

- Byte-oriented operations
- Bit-oriented operations
- · Literal and control operations

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles with the second cycle executed as a NOP. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μ s. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2 μ s.

Table 8-1 lists the instructions recognized by the MPASMTM assembler.

Figure 8-1 shows the three general formats that the instructions can have.

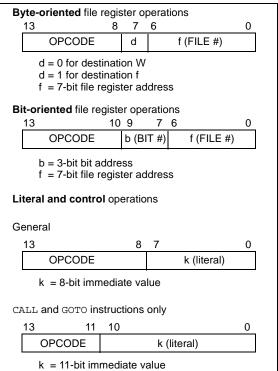
Note: To maintain upward compatibility with future PIC[®] MCU products, <u>do not use</u> the OPTION and TRIS instructions.

All examples use the following format to represent a hexadecimal number:

0xhh

where h signifies a hexadecimal digit.

FIGURE 8-1: GENERAL FORMAT FOR INSTRUCTIONS



PIC16C55X

SUBWF	Subtract W from f							
Syntax:	[label] SUBWF f,d							
Operands:	$0 \le f \le 127$ $d \in [0,1]$							
Operation:	(f) - (W) \rightarrow (dest)							
Status Affected:	C, DC, Z							
Encoding:	00 0010 dfff ffff							
Description:	Subtract (2's complement method) W register from register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.							
Words:	1							
Cycles:	1							
Example 1:	SUBWF REG1,1							
	Before Instruction							
	REG1 = 3							
	W = 2							
	C = ?							
	After Instruction							
	REG1 = 1							
	W = 2							
	C = 1; result is positive							
Example 2:	Before Instruction							
	REG1 = 2							
	W = 2 $C = ?$							
	After Instruction							
	REG1 = 0 W = 2							
	C = 1; result is zero							
Example 3:	Before Instruction							
	REG1 = 1							
	W = 2							
	C = ?							
	After Instruction							
	REG1 = 0xFF							
	W = 2							
	C = 0; result is negative							

SWAPF	Swap Nibbles in f								
Syntax:	[label] SWAPF f,d								
Operands:	$0 \le f \le 127$ d $\in [0,1]$								
Operation:	$(f<3:0>) \rightarrow (dest<7:4>),$ $(f<7:4>) \rightarrow (dest<3:0>)$								
Status Affected:	None								
Encoding:	00 1110 dfff ffff								
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0 the result is placed in W register. If 'd' is 1 the result is placed in register 'f'.								
Words:	1								
Cycles:	1								
Example	SWAPF REG, 0								
	Before Instruction								
	REG1 = 0xA5								
	After Instruction								
	REG1 = 0xA5								
	W = 0x5A								
TRIS	Load TRIS Register								
Syntax:	[<i>label</i>] TRIS f								
Operands:	$5 \le f \le 7$								
Operation:	(W) \rightarrow TRIS register f;								
Status Affected:	None								
Encoding:	00 0000 0110 Offf								
Description:	The instruction is supported for code compatibility with the PIC16C5X products. Since TRIS registers are readable and writable, the user can directly address them.								
Words:	1								
Cycles:	1								
Example									
	To maintain upward compatibility with future PIC MCU products, do								

To maintain upward compatibility with future PIC MCU products, do not use this instruction.

XORLW	Exclusive OR Literal with W						
Syntax:	[<i>label</i>] XORLW k						
Operands:	$0 \le k \le 255$						
Operation:	(W) .XOF	R. $k \rightarrow (N)$	N)				
Status Affected:	Z						
Encoding:	11	1010	kkkk	kkkk			
Description:	The contents of the W register are XOR'ed with the eight bit literal 'k'. The result is placed in the W register.						
Words:	1						
Cycles:	1						
Example:	XORLW	0xAF					
	Before In	structior	ı				
	W	=	0xB5				
	After Instruction						
	W	=	0x1A				

XORWF	Exclusive OR W with f						
Syntax:	[label] XORWF f,d						
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$						
Operation:	(W) .XOR. (f) \rightarrow (dest)						
Status Affected:	Z						
Encoding:	00 0110 dfff ffff						
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.						
Words:	1						
Cycles:	1						
Example	XORWF REG 1						
	Before Instruction						
	REG = 0xAF						
	W = 0xB5						
	After Instruction						
	REG = 0x1A						
	W = 0xB5						

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9.13 PICDEM 3 Low Cost PIC16CXXX Demonstration Board

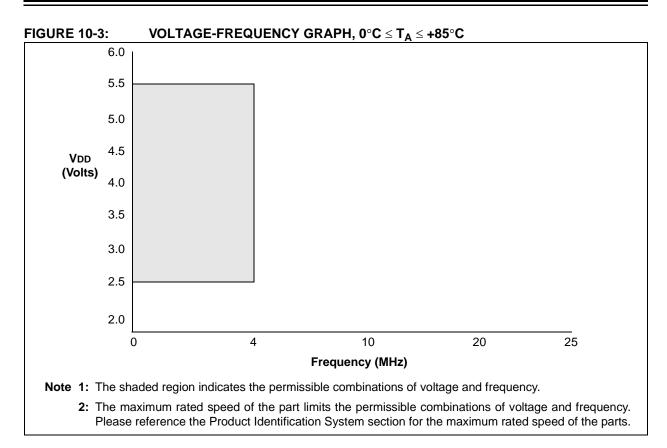
The PICDEM 3 demonstration board is a simple demonstration board that supports the PIC16C923 and PIC16C924 in the PLCC package. It will also support future 44-pin PLCC microcontrollers with an LCD Module. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM 3 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer with an adapter socket, and easily test firmware. The MPLAB ICE in-circuit emulator may also be used with the PICDEM 3 demonstration board to test firmware. A prototype area has been provided to the user for adding hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push button switches, a potentiometer for simulated analog input, a thermistor and separate headers for connection to an external LCD module and a keypad. Also provided on the PICDEM 3 demonstration board is a LCD panel, with 4 commons and 12 segments, that is capable of displaying time, temperature and day of the week. The PICDEM 3 demonstration board provides an additional RS-232 interface and Windows software for showing the demultiplexed LCD signals on a PC. A simple serial interface allows the user to construct a hardware demultiplexer for the LCD signals.

9.14 PICDEM 17 Demonstration Board

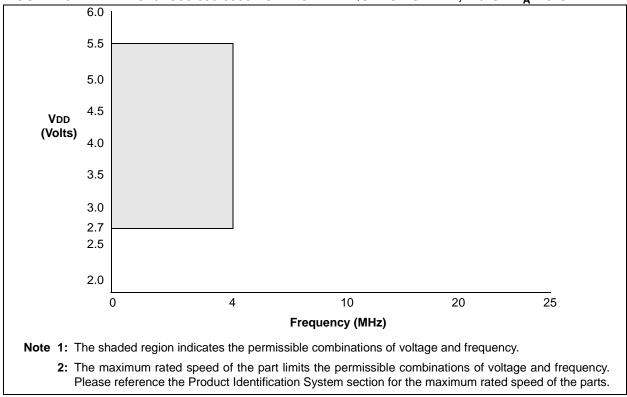
The PICDEM 17 demonstration board is an evaluation board that demonstrates the capabilities of several Microchip microcontrollers, including PIC17C752, PIC17C756A, PIC17C762 and PIC17C766. All necessary hardware is included to run basic demo programs, which are supplied on a 3.5-inch disk. A programmed sample is included and the user may erase it and program it with the other sample programs using the PRO MATE II device programmer, or the PICSTART Plus development programmer, and easily debug and test the sample code. In addition, the PICDEM 17 demonstration board supports downloading of programs to and executing out of external FLASH memory on board. The PICDEM 17 demonstration board is also usable with the MPLAB ICE in-circuit emulator, or the PICMASTER emulator and all of the sample programs can be run and modified using either emulator. Additionally, a generous prototype area is available for user hardware.

9.15 KEELOQ Evaluation and Programming Tools

KEELOQ evaluation and programming tools support Microchip's HCS Secure Data Products. The HCS evaluation kit includes a LCD display to show changing codes, a decoder to decode transmissions and a programming interface to program test transmitters.







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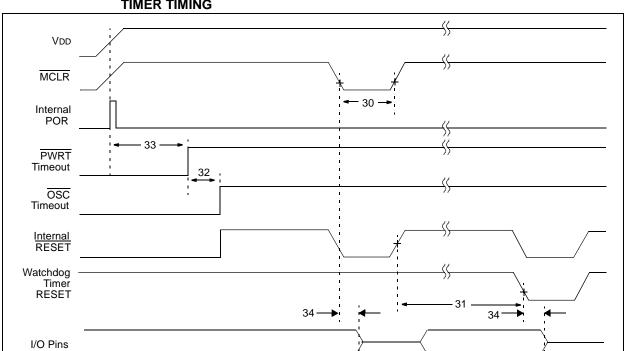


FIGURE 10-8: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

TABLE 10-3: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER REQUIREMENTS

Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2000		—	ns	-40° to +85°C
31	Twdt	Watchdog Timer Timeout Period (No Prescaler)	7*	18	33*	ms	VDD = 5.0V, -40° to +85°C
32	Tost	Oscillation Start-up Timer Period	—	1024 Tosc	—	—	Tosc = OSC1 period
33	Tpwrt	Power-up Timer Period	28*	72	132*	ms	VDD = 5.0V, -40° to +85°C
34	Tioz	I/O hi-impedance from MCLR low		—	2.0*	μS	
* These parameters are characterized but not tested							

These parameters are characterized but not tested.

Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance † only and are not tested.



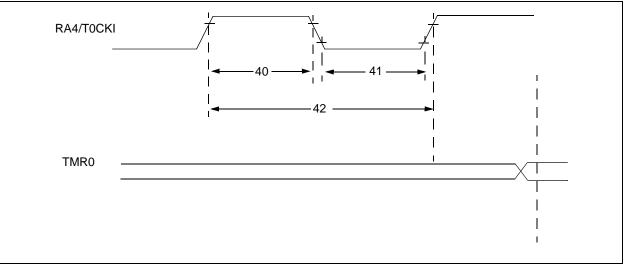


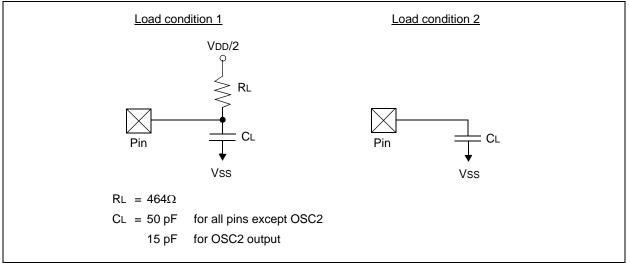
TABLE 10-4: TIMER0 CLOCK REQUIREMENTS

Param No.	Sym	Characteris	tic	Min	Тур†	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width	No Prescaler	0.5 TCY + 20*	—	_	ns	
			With Prescaler	10*	_	_	ns	
41	Tt0L	T0CKI Low Pulse Width	No Prescaler	0.5 TCY + 20*	_	_	ns	
			With Prescaler	10*	_	_	ns	
42	Tt0P	T0CKI Period		<u>Tcy + 40</u> * N		_	ns	N = prescale value (1, 2, 4,, 256)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

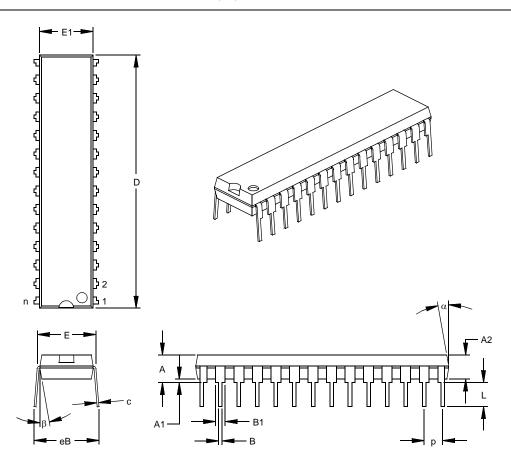
FIGURE 10-10: LOAD CONDITIONS



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28-Lead Skinny Plastic Dual In-line (SP) – 300 mil (PDIP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



ision L	imits n p	MIN	NOM	MAX	MIN	NOM	MAX
							100 01
	n		28			28	
	Р		.100			2.54	
	Α	.140	.150	.160	3.56	3.81	4.06
	A2	.125	.130	.135	3.18	3.30	3.43
	A1	.015			0.38		
	Е	.300	.310	.325	7.62	7.87	8.26
	E1	.275	.285	.295	6.99	7.24	7.49
	D	1.345	1.365	1.385	34.16	34.67	35.18
	L	.125	.130	.135	3.18	3.30	3.43
	С	.008	.012	.015	0.20	0.29	0.38
	B1	.040	.053	.065	1.02	1.33	1.65
	В	.016	.019	.022	0.41	0.48	0.56
§	eB	.320	.350	.430	8.13	8.89	10.92
	α	5	10	15	5	10	15
	β	5	10	15	5	10	15
	§	A A2 A1 E D L C B1 § α	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $

* Controlling Parameter § Significant Characteristic

Notes:

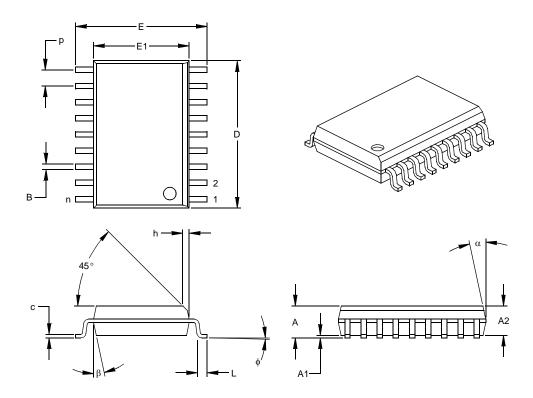
Dimension D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

.010" (0.254mm) per side. JEDEC Equivalent: MO-095

Drawing No. C04-070

18-Lead Plastic Small Outline (SO) - Wide, 300 mil (SOIC)

For the most current package drawings, please see the Microchip Packaging Specification located Note: at http://www.microchip.com/packaging



	Units		INCHES*		N	IILLIMETERS	5
Dimensi	on Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		18			18	
Pitch	р		.050			1.27	
Overall Height	Α	.093	.099	.104	2.36	2.50	2.64
Molded Package Thickness	A2	.088	.091	.094	2.24	2.31	2.39
Standoff §	A1	.004	.008	.012	0.10	0.20	0.30
Overall Width	E	.394	.407	.420	10.01	10.34	10.67
Molded Package Width	E1	.291	.295	.299	7.39	7.49	7.59
Overall Length	D	.446	.454	.462	11.33	11.53	11.73
Chamfer Distance	h	.010	.020	.029	0.25	0.50	0.74
Foot Length	L	.016	.033	.050	0.41	0.84	1.27
Foot Angle	¢	0	4	8	0	4	8
Lead Thickness	С	.009	.011	.012	0.23	0.27	0.30
Lead Width	В	.014	.017	.020	0.36	0.42	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

* Controlling Parameter § Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: MS-013

Drawing No. C04-051

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